

ASSIGNMENT

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:

SEMICONDUCTOR DEVICE AND MANUFACTURING METHOD OF
 SEMICONDUCTOR DEVICE
 for which I/WE executed an application for United States Letters Patent concurrently herewith; or filed an application for United States Letters Patent on _____, (Serial No. _____); and

WHEREAS, Shinko Electric Industries Co., Ltd., a corporation of Japan, whose post office address is 80, Oshimada-machi, Nagano-shi, Nagano, 381-2287, Japan, (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to issue upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

AND, I/WE HEREBY authorize and request the attorneys I/WE have empowered in the Declaration and Power of Attorney in this application, to insert here in parenthesis (Application No. _____, filed _____) the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, I/WE have hereunto set our hand(s).

Full Name of Sole or First Assignor Kei MURAYAMA	Assignor's Signature <i>Kei Murayama</i>	Date December 18, 2006
Address c/o Shinko Electric Industries Co., Ltd., 80, Oshimada-machi, Nagano-shi, Nagano, 381-2287, Japan		Citizenship Japan
Full Name of Second Assignor Akinori SHIRAIISHI	Assignor's Signature <i>Akinori shiraishi</i>	Date December 18, 2006
Address c/o Shinko Electric Industries Co., Ltd., 80, Oshimada-machi, Nagano-shi, Nagano, 381-2287, Japan		Citizenship Japan
Names of additional inventors attached <input checked="" type="checkbox"/> Yes <input type="checkbox"/> No		

Full Name of Third Assignor Masahiro SUNOHARA	Assignor's Signature <i>Masahiro Sunohara</i>	Date December 18, 2006
Address c/o Shinko Electric Industries Co., Ltd., 80, Oshimada-machi, Nagano-shi, Nagano, 381-2287, Japan		Citizenship Japan
Full Name of Fourth Assignor Naoyuki KOIZUMI	Assignor's Signature <i>Naoyuki KOIZUMI</i>	Date December 18, 2006
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Full Name of Fifth Assignor Hideaki SAKAGUCHI	Assignor's Signature <i>Hideaki Sakaguchi</i>	Date December 18, 2006
Address c/o Shinko Electric Industries Co., Ltd., 80, Oshimada-machi, Nagano-shi, Nagano, 381-2287, Japan		Citizenship Japan
Full Name of Sixth Assignor Mitsutoshi HIGASHI	Assignor's Signature <i>Mitsutoshi Higashi</i>	Date December 18, 2006
Address c/o Shinko Electric Industries Co., Ltd., 80, Oshimada-machi, Nagano-shi, Nagano, 381-2287, Japan		Citizenship Japan
Full Name of Seventh Assignor Yuichi TAGUCHI	Assignor's Signature <i>Yuichi Taguchi</i>	Date December 18, 2006
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Full Name of Eighth Assignor	Assignor's Signature	Date
Address		Citizenship
Full Name of Ninth Assignor	Assignor's Signature	Date
Address		Citizenship
Full Name of Tenth Assignor	Assignor's Signature	Date
Address		Citizenship
Full Name of Eleventh Assignor	Assignor's Signature	Date
Address		Citizenship
Names of additional inventors attached <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No		